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(54) Title: MEMBRANE BIOREACTOR MODULE

(57) Abstract: The present invention provides a membrane bioreactor module including base and upper assemblies between which extend an array of fibre membranes, the module further including four corner supports or columns extending between the base and upper assemblies at least one of which defines an internal fluid pathway from the base assembly to the upper assembly to facilitate the removal of permeate from the base assembly.

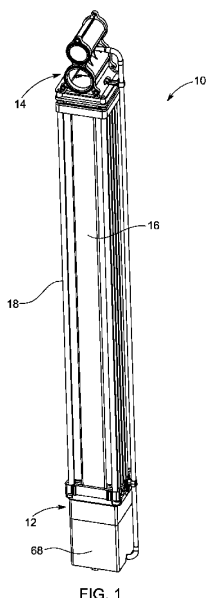


FIG. 1

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